

8 7 6 5 4 3 2 1

D

D

C

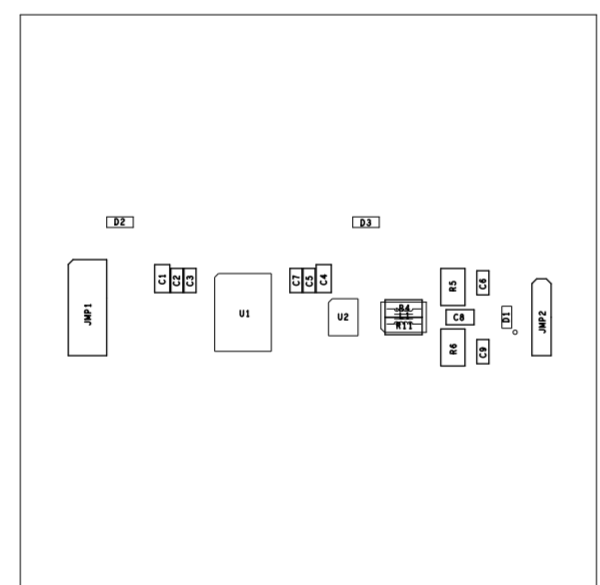
C

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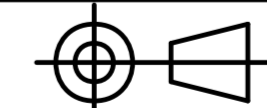
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 THIRD ANGLE PROJECTION

TOLERANCES  
 UNLESS OTHERWISE SPECIFIED  
 UNITS IN (MM)  
 IN (.XX) +/- 0.01 (.XXX) +/- 0.003  
 MM (.XX) +/- 0.01 (.XXX) +/- 0.003  
 FRACTION +/- 1/32  
 ANGLE +/- 1.0 DEGREE

APPROVALS DATE  
 DRAWN: J. NERGER 01-16-17  
 RELEASED: xxx xx-xx-xx

DO NOT SCALE DRAWING

CUSTOMER		ENGINEER J. NERGER	
BOARD NAME : ISOW + TCAN			
ASSEMBLY DRAWING (TOP SIDE)			
SIZE	ID NO.	JOB NO.	REV.
D	TIDA-00893		A
SCALE NONE		SHEET 1 OF 2	

BOARD NAME: ISOW + TCAN REFERENCE DESIGN	BOARD REV: A	ID: TIDA-00893	JOB NUMBER:
ALL ARTWORK LAYERS VIEWED FROM TOP		LAYER DESCRIPTION BOARD OUTLINE	

8 7 6 5 4 3 2 1

8 7 6 5 4 3 2 1

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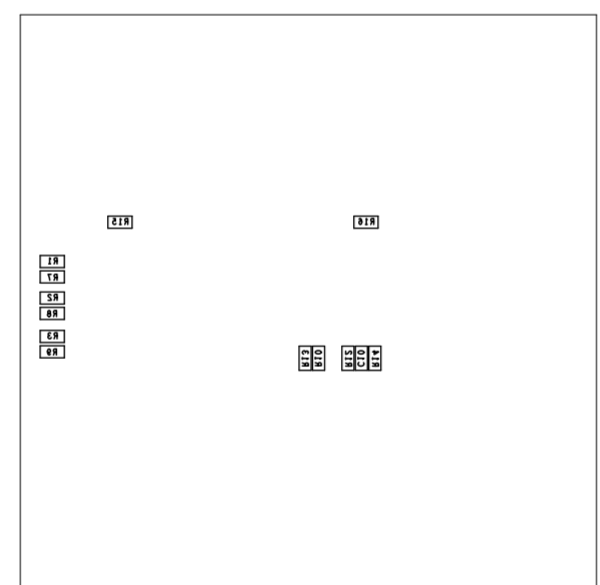
C

B

B

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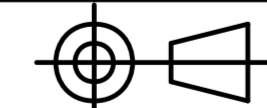
A



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 IN (.XX) +/- 0.01 (.XXX) +/- 0.003  
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 FRACTION +/- 1/32  
 ANGLE +/- 1.0 DEGREE

APPROVALS	DATE
DRAWN: J. NERGER	01-16-17
RELEASED: xxx	xx-xx-xx

DO NOT SCALE DRAWING

CUSTOMER		ENGINEER J. NERGER	
BOARD NAME : ISOW + TCAN			
ASSEMBLY DRAWING (BOTTOM SIDE)			
SIZE	ID NO.	JOB NO.	REV.
D	TIDA-00893		A
SCALE NONE		SHEET 2 OF 2	

BOARD NAME: ISOW + TCAN REFERENCE DESIGN	BOARD REV: A	ID: TIDA-00893	JOB NUMBER:
ALL ARTWORK LAYERS VIEWED FROM TOP		LAYER: BOARD ASSEMBLY BOARD OUTLINE	

8 7 6 5 4 3 2 1

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